

### 30V N-Channel Enhancement Mode MOSFET

#### Description

The PECN80S03D6 uses advanced trench technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

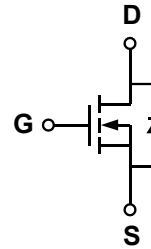
#### General Features

- ◆  $V_{DS} = 30V$   $I_D = 80A$   
 $R_{DS(ON)}(Typ.) = 3.4m\Omega$  @  $V_{GS} = 10V$   
 $R_{DS(ON)}(Typ.) = 4.9m\Omega$  @  $V_{GS} = 4.5V$
- ◆ Very low on-resistance  $R_{DS(on)}$
- ◆ 150 °C operating temperature
- ◆ 100% UIS tested 100% UIS TESTED!

#### Application

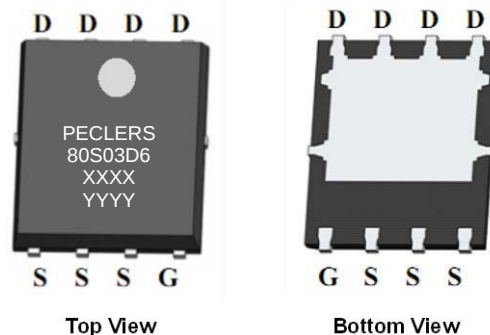
- ◆ Synchronous Rectification in DC/DC and AC/DC Converters
- ◆ Industrial and Motor Drive applications 100%  $\Delta V_{ds}$  TESTED!

#### Schematic diagram



#### Marking and pin assignment

PDFN5\*6-8L-A



#### Ordering Information

| Part Number | Storage Temperature | Package      | Devices Per Reel |
|-------------|---------------------|--------------|------------------|
| PECN80S03D6 | -55°C to +150°C     | PDFN5*6-8L-A | 5000             |

#### Absolute Maximum Ratings (TA=25°C unless otherwise noted)

| parameter                                                                                               |         | symbol   | limit   | unit |
|---------------------------------------------------------------------------------------------------------|---------|----------|---------|------|
| Drain-source voltage                                                                                    |         | $V_{DS}$ | 30      | V    |
| Gate-source voltage                                                                                     |         | $V_{GS}$ | ±20     | V    |
| Continuous Drain Current                                                                                | TC=25°C | $I_D$    | 80      | A    |
|                                                                                                         | TC=70°C |          | 56      |      |
| Avalanche energy ( $T_J = 25^\circ C$ , $V_{DD} = 30V$ , $V_G = 10V$ , $L = 0.5mH$ , $R_g = 25\Omega$ ) |         | $E_{AS}$ | 23      | mJ   |
| Power Dissipation                                                                                       | TC=25°C | $P_D$    | 30      | W    |
|                                                                                                         | TC=70°C |          | 15      |      |
| Operating junction Temperature range                                                                    |         | $T_J$    | -55—150 | °C   |

### Electrical Characteristics (TA=25°C unless otherwise noted)

| Parameter                        | Symbol              | Condition                                                                               | Min | Typ  | Max  | Unit |
|----------------------------------|---------------------|-----------------------------------------------------------------------------------------|-----|------|------|------|
| Static Characteristics           |                     |                                                                                         |     |      |      |      |
| Drain-source breakdown voltage   | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V, I <sub>D</sub> =250μA                                              | 30  | -    | -    | V    |
| Zero gate voltage drain current  | I <sub>DSS</sub>    | V <sub>DS</sub> =30V, V <sub>GS</sub> =0V                                               | -   | -    | 1    | μA   |
|                                  |                     | T <sub>J</sub> =85°C                                                                    | -   | -    | 5    |      |
| Gate Leakage Current             | I <sub>GSS</sub>    | V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V                                              | -   | -    | ±100 | nA   |
| Gate threshold voltage           | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA                                | 1.0 | 1.65 | 2.5  | V    |
| Drain-source on-state resistance | R <sub>DS(ON)</sub> | V <sub>GS</sub> =10V, I <sub>D</sub> =20A                                               | -   | 3.4  | 4.9  | mΩ   |
|                                  |                     | V <sub>GS</sub> =4.5V, I <sub>D</sub> =20A                                              |     | 4.9  | 6.5  |      |
| Forward Transconductance         | g <sub>FS</sub>     | V <sub>DS</sub> =5V,I <sub>D</sub> =20A                                                 | -   | 125  | -    | S    |
| Diode Characteristics            |                     |                                                                                         |     |      |      |      |
| Diode Forward Voltage            | V <sub>SD</sub>     | I <sub>SD</sub> =1A,V <sub>GS</sub> =0V                                                 | -   | 0.7  | 1.2  | V    |
| Diode Continuous Forward Current | I <sub>S</sub>      |                                                                                         | -   | -    | 36   | A    |
| Reverse Recovery Time            | t <sub>rr</sub>     | T <sub>J</sub> = 25°C, I <sub>F</sub> = I <sub>S</sub> di/dt = 100A/μs                  | -   | 13   | -    | ns   |
| Reverse Recovery Charge          | Q <sub>rr</sub>     |                                                                                         | -   | 22   | -    | nC   |
| Dynamic Characteristics          |                     |                                                                                         |     |      |      |      |
| Gate Resistance                  | R <sub>G</sub>      | V <sub>GS</sub> =0V, V <sub>DS</sub> =0V,f=1MHz                                         | -   | 2.6  | 4    | Ω    |
| Input capacitance                | C <sub>ISS</sub>    | V <sub>GS</sub> =0V ,V <sub>DS</sub> =15V<br>f=1.0MHz                                   | -   | 1443 | -    | pF   |
| Output capacitance               | C <sub>OSS</sub>    |                                                                                         | -   | 606  | -    |      |
| Reverse transfer capacitance     | C <sub>RSS</sub>    |                                                                                         | -   | 57   | -    |      |
| Turn-on delay time               | t <sub>D(ON)</sub>  | V <sub>GS</sub> =10V, V <sub>DS</sub> =15V, R <sub>L</sub> =1.5Ω,<br>R <sub>G</sub> =3Ω | -   | 6.5  | -    | ns   |
| Turn-on Rise time                | tr                  |                                                                                         | -   | 2.5  | -    |      |
| Turn-off delay time              | t <sub>D(OFF)</sub> |                                                                                         | -   | 26   | -    |      |
| Turn-off Fall time               | t <sub>f</sub>      |                                                                                         | -   | 3.5  | -    |      |
| Total gate charge                | Q <sub>g</sub>      | V <sub>GS</sub> =10V, V <sub>DS</sub> =15V, I <sub>D</sub> =20A                         | -   | 26   | -    | nC   |
| Gate-source charge               | Q <sub>gs</sub>     |                                                                                         | -   | 4.2  | -    |      |
| Gate-drain charge                | Q <sub>gd</sub>     |                                                                                         |     | 4.9  | -    |      |

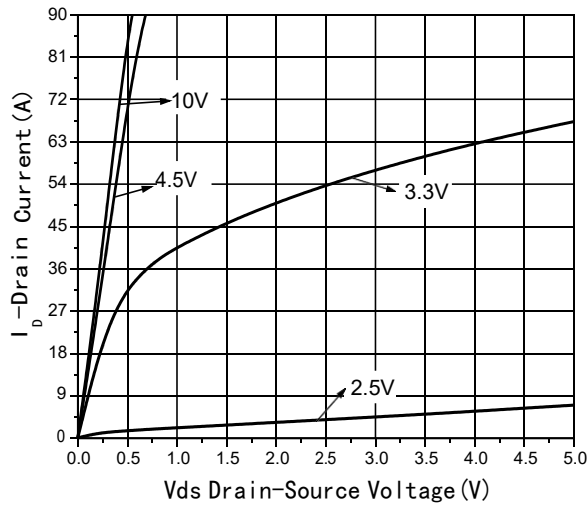
### Thermal Characteristics

| Parameter                             | Symbol                       | Typ | Max | Unit         |
|---------------------------------------|------------------------------|-----|-----|--------------|
| Maximum Junction-to-Lead <sup>B</sup> | Steady-State $R_{\theta JC}$ | 3.1 | 4   | $^\circ C/W$ |

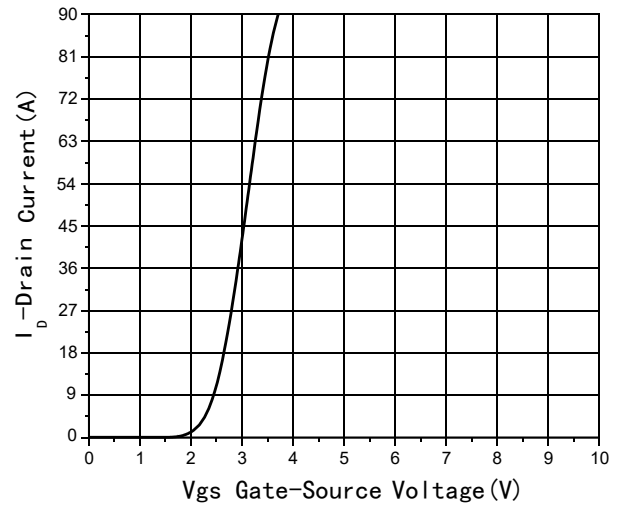
A: The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ C$ . The value in any given application depends on the user's specific board design. The current rating is based on the  $t \leq 10s$  thermal resistance rating.

B: The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to lead  $R_{\theta JL}$  and lead to ambient.

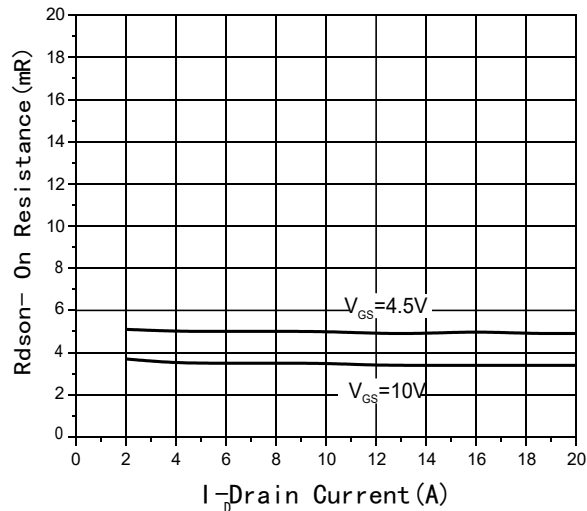
### Typical Performance Characteristics



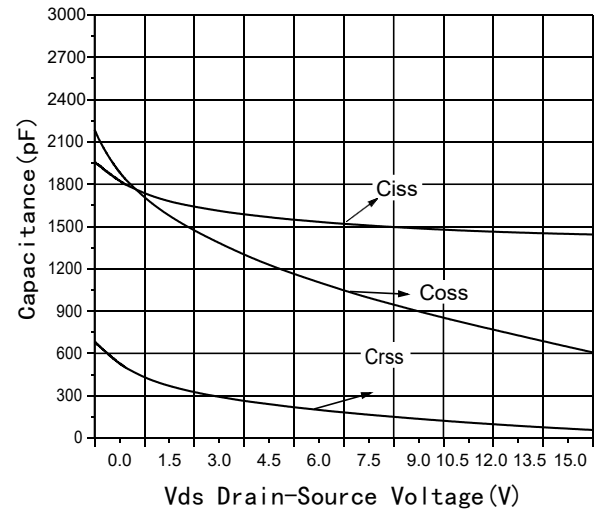
**Fig1 Output Characteristics**



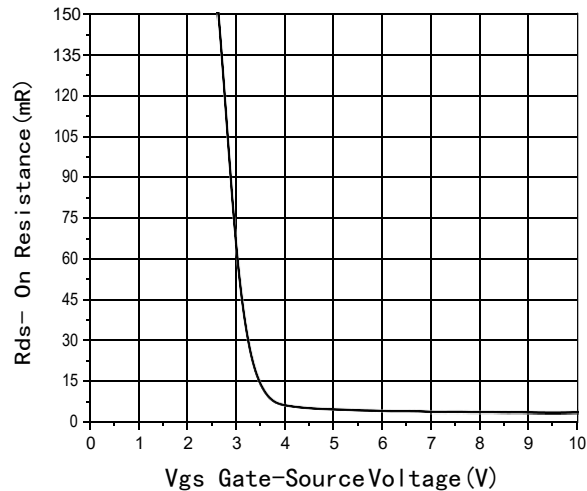
**Fig2 Transfer Characteristics**



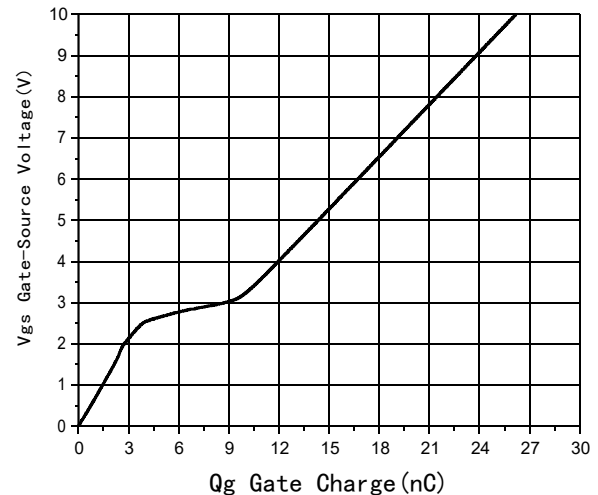
**Fig3  $R_{DS(on)}$ -Drain current**



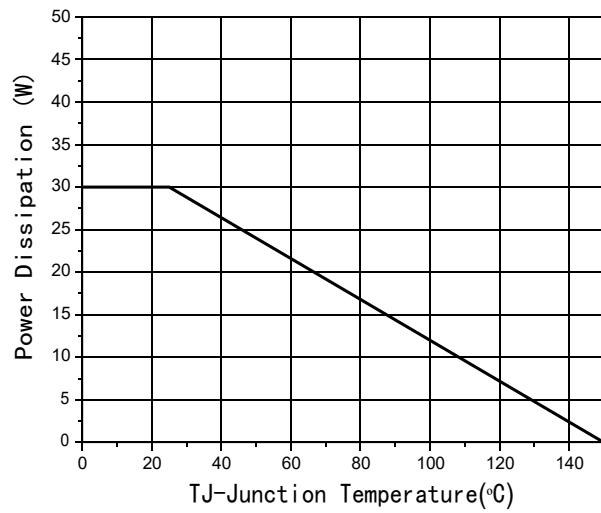
**Fig4 Capacitance vs  $V_{DS}$**



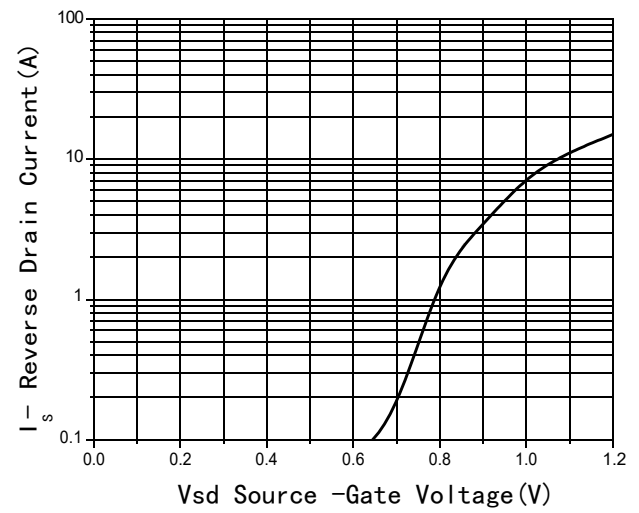
**Fig5  $R_{DS(on)}$ -Gate Drain voltage**



**Fig6 Gate Charge**



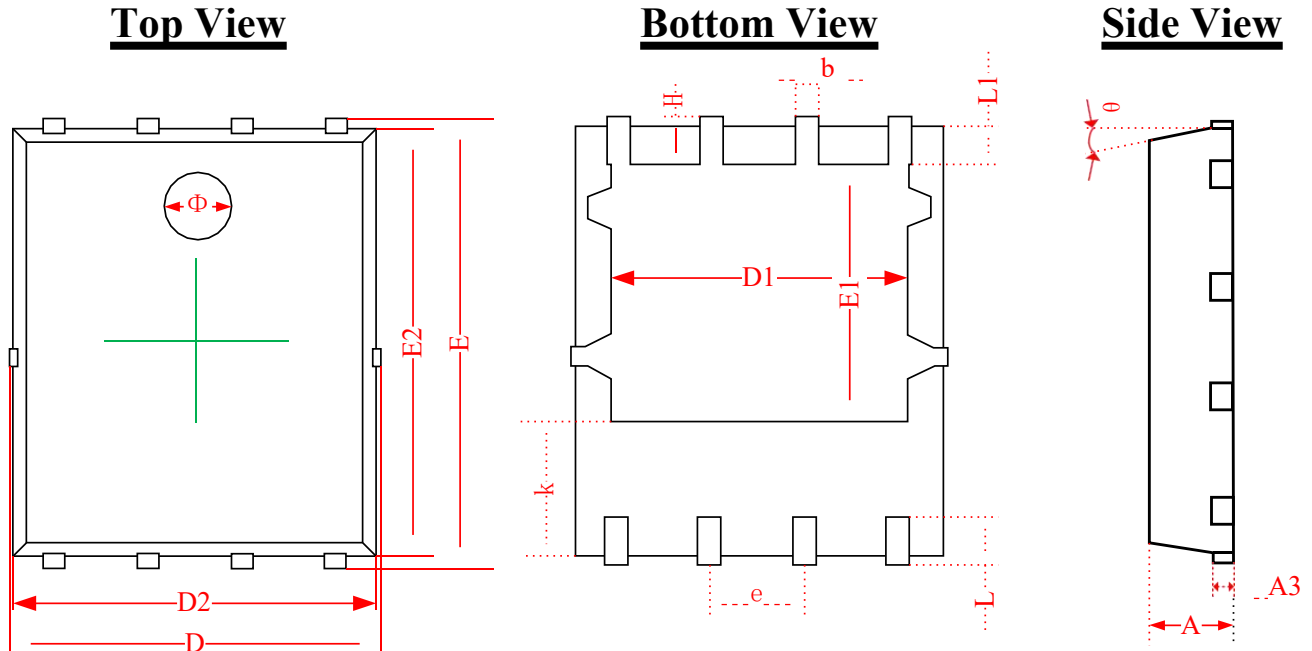
**Fig7 Power De-rating**



**Fig8 Source-Drain Diode Forward**

### Package Information

- PDFN5\*6-8L-A



| SYMBOLS | DIMENSIONS IN MILLIMETERS |       |       | DIMENSIONS IN INCHES |       |       |
|---------|---------------------------|-------|-------|----------------------|-------|-------|
|         | MIN                       | NOM   | MAX   | MIN                  | NOM   | MAX   |
| A       | 0.870                     | 0.900 | 0.930 | 0.034                | 0.035 | 0.036 |
| A3      | 0.152REF.                 |       |       | 0.006REF.            |       |       |
| D       | 4.944                     | 5.020 | 5.096 | 0.195                | 0.198 | 0.201 |
| E       | 5.974                     | 6.050 | 6.126 | 0.235                | 0.238 | 0.241 |
| D1      | 3.910                     | 4.010 | 4.110 | 0.154                | 0.158 | 0.162 |
| E1      | 3.375                     | 3.475 | 3.575 | 0.133                | 0.137 | 0.141 |
| D2      | 4.870                     | 4.900 | 4.930 | 0.192                | 0.193 | 0.194 |
| E2      | 5.720                     | 5.750 | 5.780 | 0.226                | 0.227 | 0.228 |
| k       | 1.190                     | 1.290 | 1.390 | 0.047                | 0.051 | 0.055 |
| b       | 0.350                     | 0.380 | 0.410 | 0.014                | 0.015 | 0.016 |
| e       | 1.270TYP.                 |       |       | 0.050TYP.            |       |       |
| L       | 0.559                     | 0.635 | 0.711 | 0.022                | 0.025 | 0.028 |
| L1      | 0.424                     | 0.500 | 0.576 | 0.017                | 0.020 | 0.023 |
| H       | 0.574                     | 0.650 | 0.726 | 0.023                | 0.026 | 0.029 |
| θ       | 10°                       | 11°   | 12°   | 10°                  | 11°   | 12°   |
| Φ       | 1.150                     | 1.200 | 1.250 | 0.045                | 0.047 | 0.049 |